TOSHIBA Multi-Chip Transistor

Silicon NPN Epitaxial Type, Field Effect Transistor Silicon N Channel MOS Type

TPCP8H02

STROBE FLASH APPLICATIONS HIGH-SPEED SWITCHING APPLICATIONS DC-DC CONVERTER APPLICATIONS

- Multi-chip discrete device; built-in NPN transistor for main switch and N-ch MOS FET for drive
- High DC current gain: $h_{FE} = 250$ to 400 (IC = 0.3 A) (NPN transistor)
- Low collector-emitter saturation voltage: V_{CE} (sat) = 0.14 V (max)

(NPN transistor) • High-speed switching: $t_f = 25 \text{ ns}$ (typ.) (NPN transistor)

Absolute Maximum Ratings (Ta = 25°C)

Transistor

Characteristics		Symbol	Rating	Unit	
Collector-base voltage		V _{CBO}	50	V	
Collector-emitter voltage		V _{CEX}	50	V	
		V _{CEO}	30	v	
Emitter-base voltage		V _{EBO}	6	V	
Collector current	DC (Note 1)	Ι _C	3.0	٨	
	Pulse (Note 1)	I _{CP}	5.0	A	
Base current		Ι _Β	0.3	А	
Collector power dissipation (NPN)		P _C (Note 2)	1.0	W	
Junction temperature		Тј	150	°C	



Circuit Configuration

MOS FET

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		V _{DSS}	20	V
Gate-Source Voltage		V _{GSS}	±10	V
Drain Current	DC	I _D	100	m۸
	Pulse	I _{DP}	200	ШA
Channel Temperature		T _{ch}	150	°C



Note 1: Ensure that the junction (channel) temperature does not exceed 150°C.

Note 2: Device mounted on a glass-epoxy board (FR-4,25.4 × 25.4 × 1.6 mm , Cu area: 645 mm²)

Note 3: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.

Common Absolute Maximum Rating (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Storage temperature range	T _{stg}	-55 to 150	°C

Marking (Note 4)



- Note 4: The mark " \bullet " on the lower left of the marking indicates Pin 1.
 - * Weekly code (three digits)



Electrical Characteristics (Ta = 25°C)

Transistor

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current		I _{CBO}	$V_{CB}=50~V,~I_{E}=0$			100	nA
Emitter cut-off current		I _{EBO}	$V_{EB} = 6 V, I_{C} = 0$	_	_	100	nA
Collector-emitter breakdown voltage		V (BR) CEO	$I_{C} = 10 \text{ mA}, I_{B} = 0$	30	_	_	V
DC current gain		h _{FE} (1)	$V_{CE} = 2 V, I_C = 0.3 A$	250	_	400	
		h _{FE} (2)	$V_{CE} = 2 V, I_C = 1.0 A$	120	—	_	
Collector-emitter saturation voltage		V _{CE (sat)}	$I_{C} = 1.0 \text{ A}, I_{B} = 33 \text{ mA}$	_	_	140	mV
Base-emitter saturation voltage		V _{BE (sat)}	I _C = 1.0 A, I _B = 33 mA	_	—	1.1	V
Collector output capacitance		C _{ob}	$V_{CB} = 10V$, $I_E = 0$, f=1MHz	_	18		pF
Switching time	Rise time	tr	See Figure 1 circuit diagram.	_	40	_	
	Storage time	t _{stg}	$V_{CC} \rightleftharpoons 12 \text{ V}, \text{ R}_{L} = 12 \Omega$	_	320	_	ns
	Fall time	t _f	$I_{B1} = -I_{B2} = 33 \text{ mA}$	_	25	_	

Figure 1 Switching Time Test Circuit & Timing Chart



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MOS FET

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS}=\pm 10~V,~V_{DS}=0$	_	_	±1	μA
Drain-source breakdo	own voltage	V _{(BR)DSS}	$I_D = 0.1 \text{ mA}, V_{GS} = 0$	20	—	_	V
Drain cut-off current		I _{DSS}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0$	_	—	1	μA
Gate threshold voltage		V _{th}	$V_{DS} = 3V$, $I_D = 0.1mA$	0.6	—	1.1	V
Forward transfer admittance		Yfs	$V_{DS} = 3V$, $I_D = 10mA$	40	_	_	mS
Drain-source ON-resistance		R _{DS(ON)}	$I_D = 10mA$, $V_{GS} = 4V$	_	1.5	3	Ω
			$I_D=10mA$, $V_{GS}=2.5V$	_	2.2	4	
			$I_D = 1mA$, $V_{GS} = 1.5V$	_	5.2	15	
Input capacitance		C _{iss}	V _{DS} = 3V, V _{GS} = 0, f=1MHz	_	9.3	_	pF
Reverse transfer capacitance		C _{rss}		_	4.5	_	
Output capacitance		C _{oss}		_	9.8	_	
Switching time	Turn-on time	t _{on}	See Figure 2 circuit diagram.	_	70	_	
	Turn-off time	t _{off}	$V_{DD} \rightleftharpoons 3V, R_L = 300 \Omega$ $V_{GS} = 0 \text{ to } 2.5V$		125		ns

Figure 2 Switching Time Test Circuit & Timing Chart



Gate Pulse Width 10 μ s, tr, tf<5ns (Zout=50 Ω), Common Source, Ta=25°C Duty Cycle<1%

Precautions

 V_{th} can be expressed as the voltage between gate and source when the low operating current value is ID=100 μA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} .

(The relationship can be established as follows: $\rm VGS~(off) < Vth < VGS~(on))$

Please take this into consideration when using the device. The VGS recommended voltage for turning on this product is 2.5 V or higher.

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NPN













Safe operating area 10 IC max (Pulsed) * 10 ms* 1 ms* 100 µs* 10 us IC max (Continuous) П 100 ms E 10 s* <u>ں</u> DC operation Collector current (Ta = 25°C) (Ta = 25°C) *: Single nonrepetitive pulse Ta = 25°C Note that the curves for 100 ms, 10 s and DC operation will be different when the devices aren't mounted on an FR4 board (glass epoxy, 1,6 mm thick, Cu area: 645 mm²). Single-device operation These characteristic curves must be derated linearly with increase in temperature. 0.1 VCEO max 0.01 1 100 10 $Collector-emitter \ voltage \quad V_{CE} \quad (V)$

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Nch-MOS



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